

CONNECTOR FOR FREQUENCIES BELOW 3 MHz FOR USE WITH PRINTED BOARDS

1.0 SCOPE

This Product Specification covers the 2.54 mm (0.1 inch) centerlined, 2 and 3 rows gold plated connector series terminated with solder technology to daughter cards. (right angle male)

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER (S)

Product Name 3 rows male connector style C with 96, 64, 32 and 16 contacts	and	Series 36502
3 rows male connector style C/2 with 48, 32 and 16 contacts		36503
3 rows male connector style C with 96 and 64 coding		36504
3 rows male connector style C/3 with 30 and 20 contacts		36549
2 rows male connector style B with 64 and 32 contacts		36507
2 rows male connector style B/2 with 32 and 16 contacts		36508

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See the appropriate sales drawings for information's on dimensions.

2.2.1 Material of housing Standard: High temperature Flammability:	-	Thermoplastic Polyester PCT (230°C/50 sec.) UL 94 V0	
2.2.2 Material of male contacts: CuZ		CuZn (Brass)	
2.2.3 Plating standard:		PL1 = min 1.27 μm Au over 1.5 μm PL1 = min 0.8 μm Au over 1.5 μm PL1 = min 0.3 μm Au over 1.5 μm	n Ni
2.2.4 Marking standard:		Marking of connector and packagir shall contain: Manufacturing name Part Number and Date of manufac	0
REVISION: ECR/ECN INFORMATION:	TITLE: PROD	UCT SPECIFICATION	SHEET No.
▲ EC No: I 2002-1001	For m	nale conn. DIN 41612	1 of 6

A	DATE: 2002 / 06 / 20	style B		
DOCUMEN	T NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:
PS	6-36502-001	SHIVA SHANKAR	GJLOWE	GJLOWE
			TEMPLATE FILENAM	E: PRODUCT SPEC[SIZE A4](V.1).DOC



PRODUCT SPECIFICATION

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

Normative references: for connector style for testing

DIN 41612 Part 2 and 8 / IEC 603-2 IEC 512/CECC 75101-801

4.0 RATINGS

4.1 VOLTAGE

The permissible operating voltages depend on the application and on the applicable or specified requirements.

Therefore the clearance and creepage distances are given as operating characteristics.

4.1.1	Minimum distance between contact	rows
	Creepage:	1.2 mm (0.047 in)
	Clearance:	1.2 mm (0.047 in)

4.1.2	Minimum distance between adjacent contact		
	Creepage:	1.2 mm (0.047 in)	
	Clearance:	1.2 mm (0.047 in)	

- 4.1.3Minimum distance between contact and chassis
Creepage:Creepage:1.8 mm (0.071 in)
1.6 mm (0.063 in)
- 4.2 CURRENT -

1A at 70°C (all contacts), up to 2.5 A when selective loaded

 4.3 TEMPERATURE
 -55°C to +125°C

 Operating:

 Nonoperating:

 -55°C to +125°C

4.4 CLIMATIC CATEGORY -

PL1: 55/125/56 PL2: 55/125/21 PL3: 55/125/00

4.5 BACKPLANE -

Thickness: 1.6 mm (0.063 in)

4.6 CONTACT SPACING -

2.54 mm (0.1 in)

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PRODUCT SPECIFICATION

5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Initial Contact Resistance	As per IEC 512-2, Test 2a Standard atmospheric conditions Mated connectors (refer sec 7.2.4 from IEC 603-2)	20 milliohms MAXIMUM
2	Initial Insulation Resistance	As per IEC 512-2, Test 3a: Method B Standard atmospheric conditions Test voltage 100 V + 15 V d.c. Mated connectors (refer sec 7.2.5 from IEC 603-2)	All performance levels: 10E6 Megaohms Minimum
3	Voltage Proof	As per IEC 512-2, Test 4a: (refer sec 7.2.2 from IEC 603-2) Method B Standard atmospheric conditions Mated connectors (for measuring points refer sec 8.1.5 from IEC 603-2)	For contact/contact: 1000 V (r.m.s) for B 64, C96, C64 and 1550 V (r.m.s) for C 32 For contact/test panel 1550 V (r.m.s) (Applicable for Performance level 1, 2 & 3)
4	Current carrying capacity	As per IEC 512-2, Test 5b Standard atmospheric conditions All contacts (refer sec 7.2.3 from IEC 603-2)	1A (Applicable for Performance level 1, 2 & 3)

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PRODUCT SPECIFICATION

5.2 MECHANICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
5	Connector Insertion and withdrawal Forces	As per IEC 512-7, Test 13b Maximum speed 10mm/s (0.4 in/s) (refer sec 7.3.1 from IEC 603-2)	for style C 96 - 90 N for style C 64 - 60 N for style C 32 - 30 N for style C 16 - 15 N for style C/2 48 - 45 N for style C/2 32 - 30 N for style C/2 16 - 15 N for style C/3 30 - 28.12 N for style C/3 20 - 18.75 N for style B 64 - 60 N for style B 32 - 30 N for style B/2 32 - 30 N for style B/2 16 - 15 N
6	Terminal Retention Force (in Housing)	As per IEC 512-15a, Free connectors 6 contacts/specimen	Male contacts > 10 N
7	Durability	As per IEC 512-5, Test 9a Maximum speed 10 mm/s (0.4 in/s) Rest: 30 s (unmated) (refer sec 7.3.3 from IEC 603-2)	Perf level 1: min 500 operation Perf level 2: min 400 operation Perf level 3: min 50 operation
8	Vibration (Sinusoidal)	As per IEC 512-4, Test 6d (refer sec 7.3.2 and 8.1.2 from IEC 603-2) Endurance by sweeping 10 Hz – 2000 Hz 1.5mm or 20 g Sweep cycles: 10 Duration: 7.5 h	Contact disturbance: 1 microsecond max for Performance level 1 Not applicable for Performance level 2 & 3
9	Shock (Mechanical)	As per IEC 512-4, Test 6c (refer sec 8.1.2 from IEC 603-2) Shock acceleration: 490 m/s ² (50 g) Duration of impact: 11ms	Contact disturbance: 1 microsecond max for Performance level 1 Not applicable for Performance level 2 & 3

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5.3 ENVIRONMENTAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT	
10	Rapid change of temperature	As per IEC 512-6, Test 11d -55°C to 125 °C Mated connectors duration: 30 minutes 5 cycles recovery time: 2h	Applicable to Performance level 1 & 2	
11	Climatic sequence	As per IEC 512-6, Test 11a	To be carried out for all type o connector	
11.1	Dry heat	As per IEC 512-6, Test 11i at 125°C, Test voltage 100V \pm 15V dc Mated connectors Method B (refer sec 8.1.5 from IEC 603-2)	10E5 Megaohm min for Performance level 1 & 2 10E4 Megaohm min for Performance level 3	
11.2	Damp heat cyclic, First cycle	As per IEC 512-6, Test 11m Method 1: 25°C to 55°C, Perf level 1: 55°C, Perf level 2: 40°C Relative humidity: 95% Recovery time: 2h	Applicable for Performance level 1 & 2	
11.3	Cold	As per IEC 512-6, Test 11j for - 55°C Duration: 2h Recovery time: 2h	Applicable for Performance level 1,2 & 3	
11.4	Damp heat cyclic, Remaining cycles	As per IEC 512-6, Test 11m	For Performance level 1: 5 cycles For Performance level 2: 1 cycle	
11.5	Damp heat Steady state	As per IEC 512-6, Test 11c At 40°C and 95 % relative humidity Polarization voltage: 60 V dc Conditions according to sec 7.1 as per IEC 603-2 Connection points and conditions according to sec 8.1.5 as per IEC 603-2	For Performance level 1: 56 days For Performance level 2: 21 days	
11.6.1	Corrosive (Industrial	As per IEC 512-6, Test 11g Method A: 10 ppm SO2 + Method B: 1 ppm H2S	For Performance level 1: 10 days + 4 days For Performance level 2: 4 days + 4 days	
11.6.2	Atmosphere) (half mated; half unmated)	Mixed gas: 0.5 ppm SO2 + 0.1 ppm H2S (for test method refer Annex A from IEC 603-2)	For Performance level 1: 10 days For Performance level 2: 4 days	
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DATE: 2002 / 06 / 20		style B & C solde	r version	

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 Style B & C Solder Version

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5.3 ENVIRONMENTAL REQUIREMENTS (continued)

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
		As per IEC 512 -12a, Test Ta, Method 1 Free board connector: immersion depth 2.6mm min.	Applicable for Performance level 1, 2 & 3
12	Solderability &	Fixed board connector: Board thickness up to 1.6 mm, immersion depth 2.0 mm min.	Not applicable for solderless termination techniques
	Aging	Board thickness up to 2.4 mm immersion depth 3.5 mm min.	
		Aging Test 3, duration 16 hours dry heat at 155°C (refer Test Ba of IEC Publication 68-2-2)	Visual: No Damage

6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage.

7.0 SPECIAL FEATURE

- 7.1 Coding device
- 7.2 First make last break contacts
- 7.3 Last make first break contacts
- 7.4 Retention clip
- 7.5 Lubrication (polyphenylether)7.6 Anti flux treatment: DIN 41640 part 84

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